

## PMP9385 REV E1 Bill of Materials

Designator	Quantity	Value	PartNumber	Manufacturer	Description	PackageReference
I PCB	1		PMP7950 rev1	Any	PMP7950 rev1	N/A
C6	1	22uF	TMK325B7226MM	Taiyo Yuden	CAP, CERM, 22uF, 25V, X7R, 20%, 1210	1210
C7	1	330uF	UCD2A331MNQ1MS	Nichicon	CAP, Al Electrolytic, 330uF, 100V, +/-20%, SMT	
C8	1	3.3uF	GRM32DR71H335KA88L	MuRata	CAP, CERM, 3.3uF, 50V, +/-10%, X7R, 1210	1210
C15	1	0.1uF	08053C104KAT2A	AVX	CAP, CERM, 0.1uF, 25V, +/-10%, X7R, 0805	0805
C16, C20	2	100pF	GRM1885C1H101JA01D	MuRata	CAP, CERM, 100pF, 50V, +/-5%, COG/NP0, 0603	0603
C17	1	4.7uF	GRM21BR71C475KA73L	MuRata	CAP, CERM, 4.7uF, 16V, +/-10%, X7R, 0805	0805
C19, C21	2	0.47uF	GRM188R71E474KA12D	MuRata	CAP, CERM, 0.47uF, 25V, +/-10%, X7R, 0603	0603
C22	1	1uF	GRM219R71E105KA88D	MuRata	CAP, CERM, 1uF, 25V, +/-10%, X7R, 0805	0805
C23	1	68pF	06035A680JAT2A	AVX	CAP, CERM, 68pF, 50V, +/-5%, COG/NP0, 0603	0603
C24	1	2700pF	GRM188R71H272KA01D	MuRata	CAP, CERM, 2700pF, 50V, +/-10%, X7R, 0603	0603
C26	1	1uF	GRM188R71E105KA12D	MuRata	CAP, CERM, 1uF, 25V, +/-10%, X7R, 0603	0603
Cx1, Cx2	2	390uF	PCV1E391MCL2GS	Nichicon	CAP, Conductive Polymer Al Electrolytic, 390uF, 25V, +/-20%, 0.021Ohm ESR, SMT	Used in PnP output
D1	1	0.77V	DFLS1100-7	Diodes Inc.	Diode, Schottky, 100V, 1A, PowerDI123	PowerDI123
H1, H2, H3, H4	4		NY PMS 440 0025 PH	B&F Fastener Supply	Machine Screw, Round, #4-40 x 1/4, Nylon, Philips panhead	Screw
H5, H6, H7, H8	4		1902C	Keystone	Standoff, Hex, 0.5"L #4-40 Nylon	Standoff
J1	1	2x1	1715721	Phoenix Contact	Conn Term Block, 2POS, 5.08mm, TH	2POS Terminal Block
J2	1	2x1	1751248	Phoenix Contact	Conn Term Block, 2POS, 3.5mm, TH	11x8.5x7.3mm
L1	1	3uH	XAL1580-302MEB	Coilcraft	Inductor, Shielded, Composite, 3uH, 34.4A, 0.002619 ohm, SMD	15.2x8x16.2mm
LBL1	1		THT-14-423-10	Brady	Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll	PCB Label 0.650"H x 0.200"W
Q1, Q3	2	60V	CSD18531Q5A	Texas Instruments	MOSFET, N-CH, 60V, 19A, SON 5x6mm	SON 5x6mm
Q6	1	0.2V	MMBT3904	Fairchild Semiconductor	Transistor, NPN, 40V, 0.2A, SOT-23	SOT-23
Q7	1	0.25V	MMBT3906	Fairchild Semiconductor	Transistor, PNP, 40V, 0.2A, SOT-23	SOT-23
R2	1	0.004	KRL7638-C-R004-F-T1	Susumu	RES 0.004 OHM 3W 1% 3015 WIDE	Wide 3015 (7638 Metric), 1530
R3, R4	2	100	CRCW0603100RFKEA	Vishay-Dale	RES, 100 ohm, 1%, 0.1W, 0603	0603
R5, R8, R9, R10, R14	5	0	ERJ-3GEY0R00V	Panasonic	RES, 0 ohm, 5%, 0.1W, 0603	0603
R11	1	49.9k	CRCW060349K9FKEA	Vishay-Dale	RES, 49.9k ohm, 1%, 0.1W, 0603	0603
R12	1	2.2	CRCW08052R20JNEA	Vishay-Dale	RES, 2.2 ohm, 5%, 0.125W, 0805	0805
R13	1	45.3k	CRCW060345K3FKEA	Vishay-Dale	RES, 45.3k ohm, 1%, 0.1W, 0603	0603
R15	1	6.49k	CRCW06036K49FKEA	Vishay-Dale	RES, 6.49k ohm, 1%, 0.1W, 0603	0603
R16	1	37.4k	CRCW060337K4FKEA	Vishay-Dale	RES, 37.4k ohm, 1%, 0.1W, 0603	0603
R18	1	44.2k	CRCW060344K2FKEA	Vishay-Dale	RES, 44.2k ohm, 1%, 0.1W, 0603	0603
R19	1	523	CRCW0603523RFKEA	Vishay-Dale	RES, 523 ohm, 1%, 0.1W, 0603	0603
R20	1	10.0k	CRCW060310K0FKEA	Vishay-Dale	RES, 10.0k ohm, 1%, 0.1W, 0603	0603
R21	1	48.7	CRCW080548R7FKEA	Vishay-Dale	RES, 48.7 ohm, 1%, 0.125W, 0805	0805
R24	1	0	CRCW06030000Z0EA	Vishay-Dale	RES, 0 ohm, 5%, 0.1W, 0603	0603
TP1, TP3	2	Red	5010	Keystone	Test Point, Multipurpose, Red, TH	Red Multipurpose Testpoint
TP2, TP7, TP8	3	White	5012	Keystone	Test Point, Multipurpose, White, TH	White Multipurpose Testpoint
TP4, TP5	2	Black	5011	Keystone	Test Point, Multipurpose, Black, TH	Black Multipurpose Testpoint
U1	1		LM5122MHX/NOPB	Texas Instruments	Wide Input Synchronous Boost Controller with Multiple Phase Capability, PWP0020A	PWP0020A

Designator	Quantity	Value	PartNumber	Manufacturer	Description	PackageReference
C1	0	470pF	GRM2165C2A471JA01D	MuRata	CAP, CERM, 470pF, 100V, +/-5%, C0G/NP0, 0805	0805
C2, C13, C14	0	330uF	EEV-FK2A331M	Panasonic	CAP, AL, 330uF, 100V, +/-20%, 0.153 ohm, SMD	SMT Radial K16
C3, C4, C5	0	3.3uF	GRM32DR71H335KA88L	MuRata	CAP, CERM, 3.3uF, 50V, +/-10%, X7R, 1210	1210
C9, C10, C11, C12, C27	0	1uF	GRM32CR72A105KA35L	MuRata	CAP, CERM, 1uF, 100V, +/-10%, X7R, 1210	1210
C18	0	100pF	GRM1885C1H101JA01D	MuRata	CAP, CERM, 100pF, 50V, +/-5%, C0G/NP0, 0603	0603
C25	0	1uF	GRM188R71E105KA12D	MuRata	CAP, CERM, 1uF, 25V, +/-10%, X7R, 0603	0603
D2	0	0.57V	PMEG6010CEH,115	NXP Semiconductor	Diode, Schottky, 60V, 1A, SOD-123F	SOD-123F
FID1, FID2, FID3	0		N/A	N/A	Fiducial mark. There is nothing to buy or mount.	Fiducial
Q2	0	60V	CSD18531Q5A	Texas Instruments	MOSFET, N-CH, 60V, 19A, SON 5x6mm	SON 5x6mm
Q4, Q8	0	0.2V	MMBT3904	Fairchild Semiconductor	Transistor, NPN, 40V, 0.2A, SOT-23	SOT-23
Q5, Q9	0	0.25V	MMBT3906	Fairchild Semiconductor	Transistor, PNP, 40V, 0.2A, SOT-23	SOT-23
R1	0	8.2	CRCW20108R20JNEF	Vishay Dale	RES 8.2 OHM 3/4W 5% 2010 SMD	2010 (5025 Metric)
R6, R7, R17	0	0	ERJ-3GEY0R00V	Panasonic	RES, 0 ohm, 5%, 0.1W, 0603	0603
TP6	0	Yellow	5009	Keystone	Test Point, Compact, Yellow, TH	Yellow Compact Testpoint

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